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FAIRCHILD

FDW2520C

Complementary PowerTrench[®] MOSFET

General Description

This complementary MOSFET device is produced using Fairchild's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

Applications

- DC/DC conversion
- Power management
- Load switch

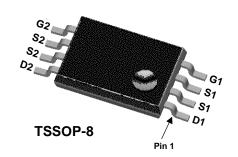
Features

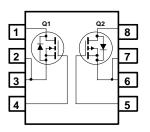
- Q1:
 N-Channel

 6 A, 20 V.
 $R_{DS(ON)}$ = 18 m Ω @ V_{GS} = 4.5 V

 $R_{DS(ON)}$ = 28 m Ω @ V_{GS} = 2.5 V
- Q2: P-Channel

 -4.4A, 20 V. R_{DS(ON)} = 35 mΩ @ V_{GS} = -4.5 V
 R_{DS(ON)} = 57 mΩ @ V_{GS} = -2.5 V
- High performance trench technology for extremely
 low R_{DS(ON)}
- Low profile TSSOP-8 package





Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Q1	Q2	Units	
V _{DSS}	Drain-Sour	ce Voltage		20	-20	V
V _{GSS}	Gate-Sourc	e Voltage		±12	±12	V
I _D	Drain Curre	nt - Continuous	(Note 1a)	6	-4.4	A
		- Pulsed		30	-30	
PD	Power Diss	ipation	(Note 1a)	1.0		W
			(Note 1b)	0.6		
T _J , T _{STG}	Operating a	and Storage Junction T	Storage Junction Temperature Range -55 to +150		°C	
0, 010	oporating		emperature Range	-55 10	100	U
	I Charac	Ū			25	°C/W
Therma _{R₀JA} Packag	Il Charac	teristics	Ambient (Note 1a) (Note 1b)	12	25	

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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Char	acteristics	·			•	•	•
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA V _{GS} = 0 V, I _D = -250 μA	Q1 Q2	20 20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C $I_D = -250 \ \mu$ A, Referenced to 25°C	Q1 Q2		14 -17		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 V, V_{GS} = 0 V$ $V_{DS} = -16 V, V_{GS} = 0 V$	Q1 Q2			1 _1	μA
GSS	Gate-Body Leakage	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$	Q1 Q2			<u>+</u> 100 +100	nA
On Chara	acteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A V_{DS} = V_{GS} , I_D = -250 μ A	Q1 Q2	0.4 0.4	1.0 -1.0	1.5 -1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C I_D = -250 µA, Referenced to 25°C	Q1 Q2		-3.3 3.1		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance		Q1		14 19 19	18 28 29	mΩ
		$V_{GS} = -4.5 V$, $I_D = -4.4 A$ $V_{GS} = -2.5 V$, $I_D = -3.3 A$	Q2		28 43 39	35 57 56	mΩ
D _(on)	On-State Drain Current	$V_{GS} = -4.5 V, I_D = -4.4 A, T_J = 125^{\circ}C$ $V_{GS} = 4.5 V, V_{DS} = 5 V$ $V_{GS} = -4.5 V, V_{DS} = -5 V$	Q1 Q2	30 30			A
g _{FS}	Forward Transconductance	$V_{GS} = -4.5 V, V_{DS} = -5 V$ $V_{DS} = 5 V, I_D = 6 A$ $V_{DS} = -5 V, I_D = -4.4 A$	Q1 Q2		30 17		S
Dvnamic	Characteristics	.					
C _{iss}	Input Capacitance	Q1: V _{DS} = 10 V, V _{GS} = 0 V,	Q1 Q2		1325 1330		pF
C _{oss}	Output Capacitance	f = 1.0 MHz Q2:	Q1 Q2		358 552		pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = –10 V, V _{GS} = 0 V, f = 1.0 MHz	Q1 Q2		168 153		pF
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time	Q1: V _{DD} = 10 V, I _D = 1 A,	Q1 Q2		6 12	20 25	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5V, R_{GEN} = 6 \Omega$ Q2:	Q1 Q2		11 19	40 40	ns
t _{d(off)}	Turn-Off Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_D = -1 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	Q1 Q2		32 60	60 100	ns
t f	Turn-Off Fall Time		Q1 Q2		19 37	34 70	ns
Qg	Total Gate Charge	Q1: V _{DS} = 10 V, I _D = 6 A,	Q1 Q2		14 14	20 20	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$ Q2:	Q1 Q2		2.6 3.0		nC
Q _{gd}	Gate-Drain Charge	$V_{DS} = -5 V, I_D = -4.4 A,$ $V_{GS} = -4.5 V$	Q1 Q2		3.7 3.9		nC

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-So	ource Diode Characterist	tics and Maximum Ratings					
		tics and Maximum Ratings Source Diode Forward Current	Q1			0.83	A
Drain-Sc		0	Q1 Q2			0.83 0.83	A
		Source Diode Forward Current			0.5		A

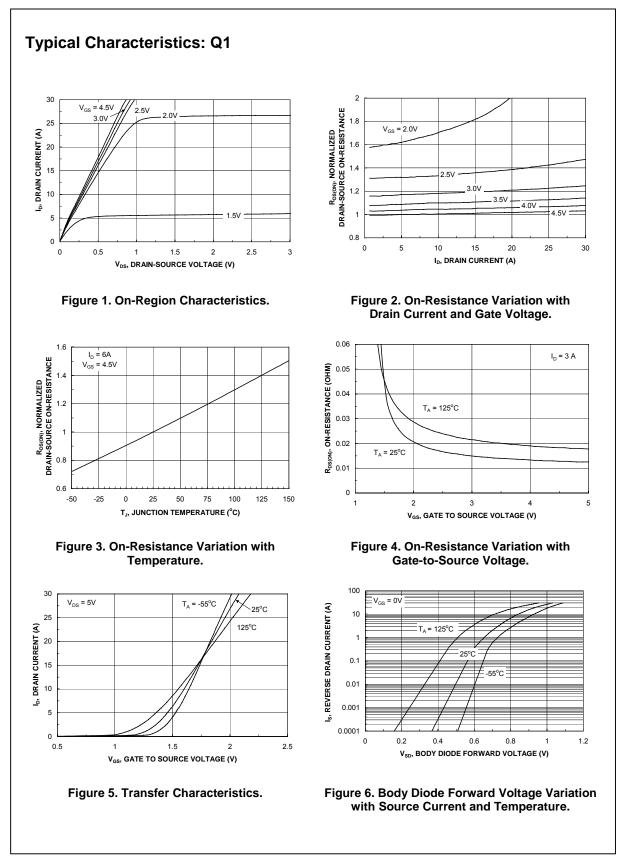
Notes:

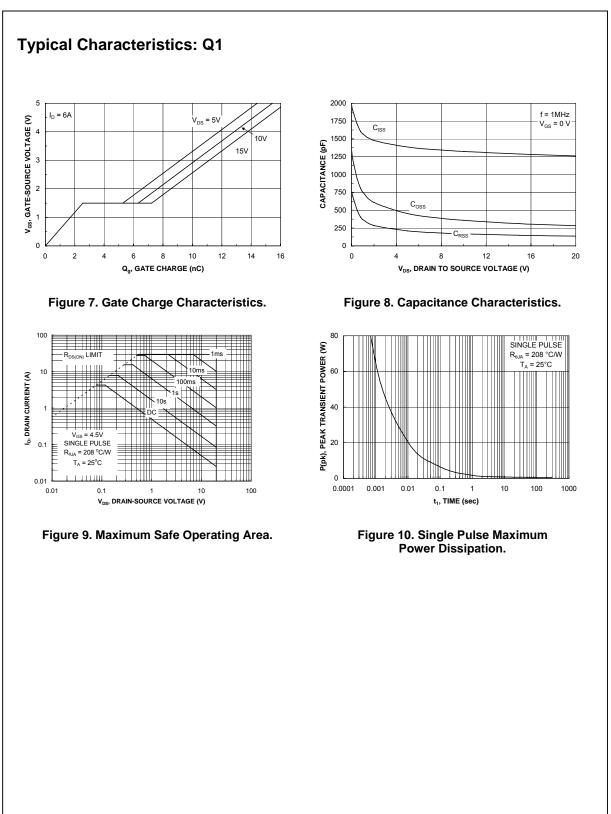
1. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJC} is guaranteed by design while R_{BCA} is determined by the user's board design.

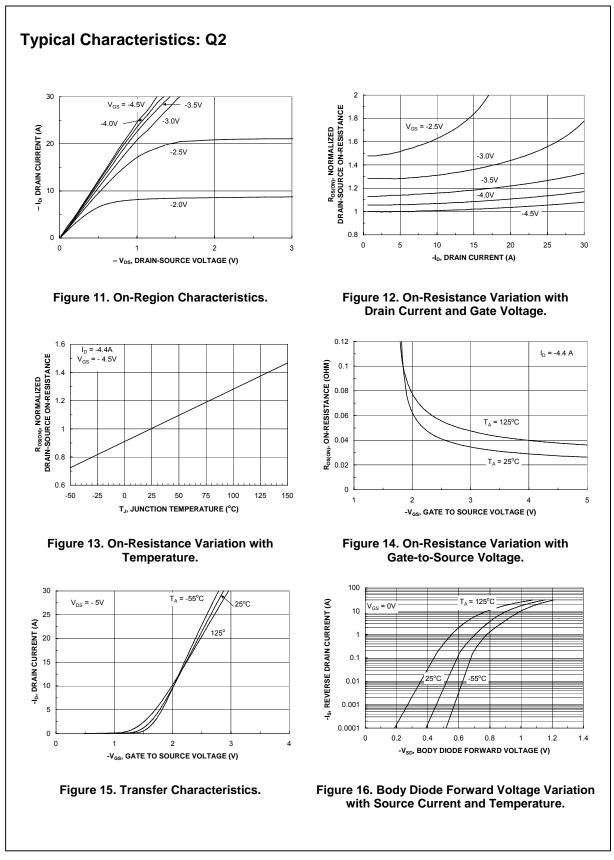
a) $R^{}_{\theta JA}$ is 125°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4.

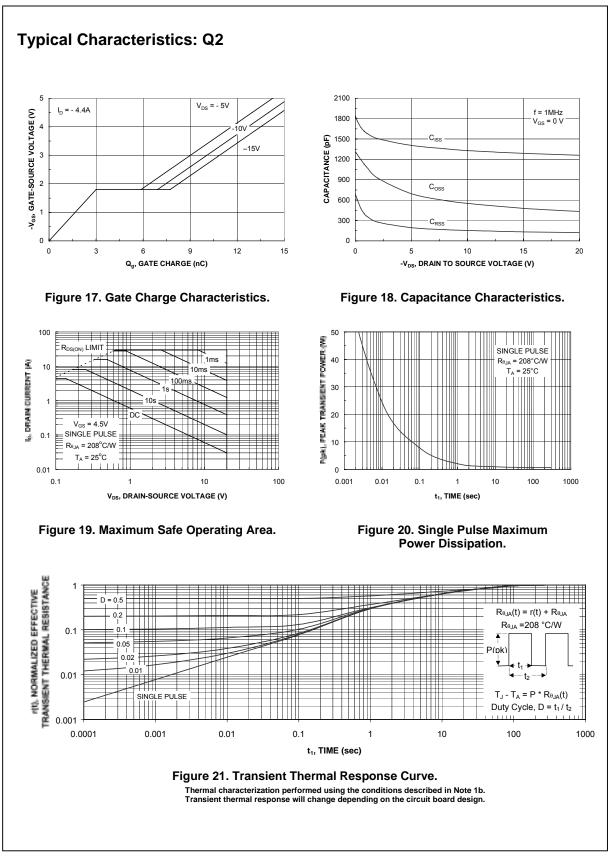
b) R_{0JA} is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%











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